

## PATENT ASSIGNMENT

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SUBMISSION TYPE:	NEW ASSIGNMENT														
NATURE OF CONVEYANCE:	ASSIGNMENT														
CONVEYING PARTY DATA															
<table border="1"><thead><tr><th>Name</th><th>Execution Date</th></tr></thead><tbody><tr><td>Sung Soo RYU</td><td>01/27/2006</td></tr><tr><td>Seon Cheol PARK</td><td>01/27/2006</td></tr><tr><td>Sang Pyo LEE</td><td>01/27/2006</td></tr><tr><td>Dong Sook SINN</td><td>01/27/2006</td></tr><tr><td>Sang Kyun LEE</td><td>01/27/2006</td></tr><tr><td>Dang Hyok YOON</td><td>01/27/2006</td></tr></tbody></table>	Name	Execution Date	Sung Soo RYU	01/27/2006	Seon Cheol PARK	01/27/2006	Sang Pyo LEE	01/27/2006	Dong Sook SINN	01/27/2006	Sang Kyun LEE	01/27/2006	Dang Hyok YOON	01/27/2006	
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RECEIVING PARTY DATA															
Name:	Samsung Electro-Mechanics Co., Ltd.														
Street Address:	314 MAETAN-3-DONG, YOUNGTONG-KU														
City:	SUWON, KYUNGKI-DO														
State/Country:	REPUBLIC OF KOREA														
PROPERTY NUMBERS Total: 1															
<table border="1"><thead><tr><th>Property Type</th><th>Number</th></tr></thead><tbody><tr><td>Application Number:</td><td>12340041</td></tr></tbody></table>	Property Type	Number	Application Number:	12340041											
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Application Number:	12340041														
CORRESPONDENCE DATA															
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<i>Correspondence will be sent via US Mail when the fax attempt is unsuccessful.</i>															
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NAME OF SUBMITTER:	Ayesha Wilson														

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PATENT  
REEL: 022009 FRAME: 0615

Total Attachments: 2

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**PATENT**

**REEL: 022009 FRAME: 0616**

Docket No.

**ASSIGNMENT**

In consideration of the premises and other good and valuable consideration in hand paid, the receipt and sufficiency of which is hereby acknowledged, the undersigned,

(1) <u>RYU, Sung Soo</u>	(4) <u>SINN, Dong Sook</u>
(2) <u>PARK, Seon Cheol</u>	(5) <u>LEE, Sang Kyun</u>
(3) <u>LEE, Sang Pyo</u>	(6) <u>YOON, Dang Hyok</u>

who have made a certain new and useful invention, hereby sell, assign and transfer unto

SAMSUNG ELECTRO-MECHANICS CO., LTD.

314 Maetan-3-dong, Youngtong-ku,

Suwon, Kyungki-do, Republic of Korea

its successors and assigns (hereinafter designated "ASSIGNEE") the entire right, title and interest for the United States of America as defined in 35 U.S.C. 100 in the invention entitled METHOD FOR MANUFACTURING DIELECTRIC CERAMIC POWDER, AND MULTILAYER CERAMIC CAPACITOR OBTAINED BY USING THE CERAMIC POWDER

(a) for which an application for United States Letters Patent was filed on \_\_\_\_\_, and identified by United States Serial No. \_\_\_\_\_;

or



(b) for which an application for United States Letters Patent was executed on \_\_\_\_\_,

and the undersigned hereby authorize and request the United States Commissioner of Patents and Trademarks to issue any and all United States Letters Patent which may be granted therefor and any and all extensions, divisions, reissues, substitutes, renewals, continuations, or continuations-in-part thereof, and the right to all benefits under the International Convention for the Protection of Industrial Property to the said ASSIGNEE, for its interest as ASSIGNEE, its successors, assigns and legal representatives; the undersigned agree that the attorneys of record in said application shall hereafter act on behalf of said ASSIGNEE;

AND the undersigned hereby agree to transfer a like interest, and to

render all necessary assistance in making application for and obtaining original, divisional, reissued or extended Letters Patent of the United States, upon request of the said ASSIGNEE, its successors, assigns and legal representatives, and without further remuneration, in and to any improvements, and applications for patent based thereon, growing out of or related to the said invention; and to execute any papers by the said ASSIGNEE, its successors, assigns and legal representatives, deemed essential to ASSIGNEE's full protection and title in and to the invention hereby transferred.

SIGNED on the dates indicated aside our signatures:

INVENTOR(S)	DATE SIGNED
1)  Name: RYU, Sung Soo	<u>January 27, 2006</u>
2) <u>PARK, Seon Cheol</u> Name: PARK, Seon Cheol	<u>January 27, 2006</u>
3) <u>Lee Sang pyo</u> Name: LEE, Sang Pyo	<u>January 27, 2006</u>
4)  Name: SINN, Dong Sook	<u>January 27, 2006</u>
5) <u>Lee Sang kyun</u> Name: LEE, Sang Kyun	<u>January 27, 2006</u>
6) <u>윤 당 혁</u> Name: YOON, Dang Hyok	<u>January 27, 2006</u>